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ABSTRACT

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**APPARATUS FOR ASSEMBLING
INTEGRATED CIRCUIT PACKAGES**

The invention relates to an apparatus (10) for the manufacture of a component such as an integrated circuit chip, including: a plurality of
10 processing stations (14a, 14b, 16, 18a, 18b, 18c, 19, 20, 22, 24, 26, 28)
forming a production line for the manufacture of said component; conveying
means (42) adapted to transport component forming materials from one
processing station to another in the production line; and storage means (17)
15 of the production line for storing said materials during transport along the
production line.

The storage means (17) acts as buffers effectively to collect materials and store them for efficient transport along the production line.

(FIG. 1)



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